

Technical Data Sheet

Chip LED with Right Angle Lens

12-21/S2C-AQ2R2B/2C

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version

Descriptions

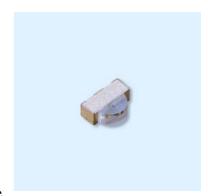
- The 12-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

	Chip	F . 24 . 1 C . 1	Resin Color	
Part No.	Material	Emitted Color		
12-21/S2C-AQ2R2B/2C	AlGaInP	Brilliant Orange	Water Clear	



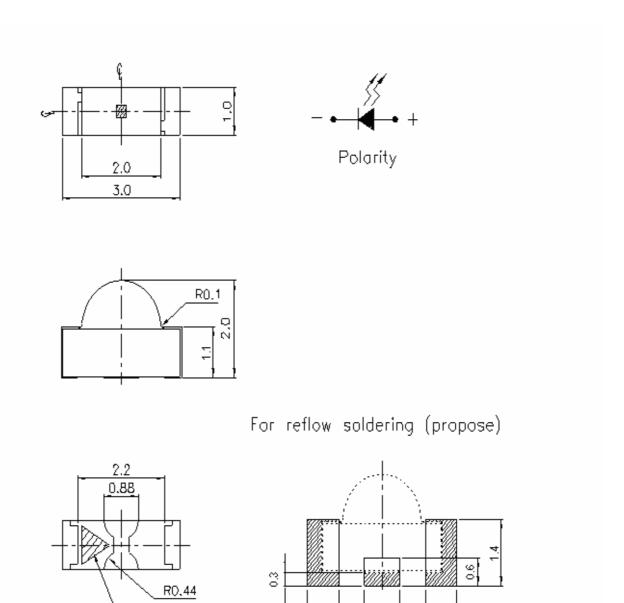
Rev. 1

Prepared by: Deng Bo



12-21/S2C-AQ2R2B/2C

Package Outline Dimensions



0.8

0.65

0.9

0.65

0.8

Page: 2 of 10

Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Cathode mark

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1



12-21/S2C-AQ2R2B/2C

Page: 3 of 10

Rev. 1

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I_{F}	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	60	mA	
Power Dissipation	P_{d}	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	$I_{\rm v}$	90.0		180	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λp		611		nm	
Dominant Wavelength	λd	600.5		612.5	nm	$I_F = 20 \text{mA}$
Spectrum Radiation Bandwidth	Δλ		17		nm	
Forward Voltage	V_{F}	1.75		2.35	V	
Reverse Current	I_R			10	μ A	V _R =5V

Notes:

1. Tolerance of Luminous Intensity $\pm 11\%$

2.Tolerance of Dominant Wavelength ±1nm

3. Tolerance of Forward Voltage $\pm 0.1 V$

Everlight Electronics Co., Ltd.

http://www.everlight.com



12-21/S2C-AQ2R2B/2C

Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
A	D8	600.5	603.5			
	D9	603.5	606.5	nm	I -20m A	
	D10	606.5	609.5		$I_F = 20 \text{mA}$	
	D11	609.5	612.5			

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
Q2	90.0	112.0		
R1	112	140	mcd	$I_F = 20 \text{mA}$
R2	140	180		

Bin Range Of Forward Voltage

bin Runge of Forward voltage					
Group	Bin	Min	Max	Unit	Condition
	0	1.75	1.95		
В	1	1.95	2.15	V	$I_F = 20 \text{mA}$
	2	2.15	2.35		

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Page: 4 of 10

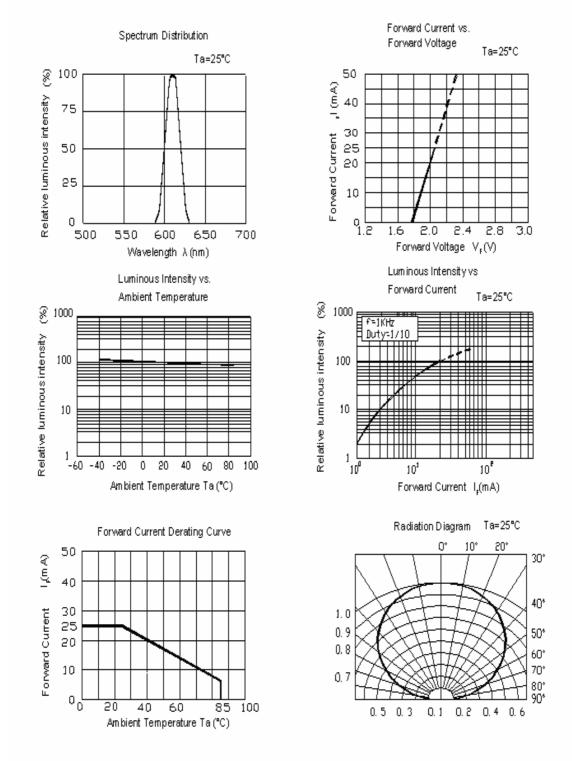
Device No.: DSE-0003457 Prepared date: 02-Apr-2010 Prepared by: Deng Bo

Rev. 1



12-21/S2C-AQ2R2B/2C

Typical Electro-Optical Characteristics Curves



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 5 of 10 Device No.: DSE-0003457 Prepared date: 02-Apr-2010 Prepared by: Deng Bo



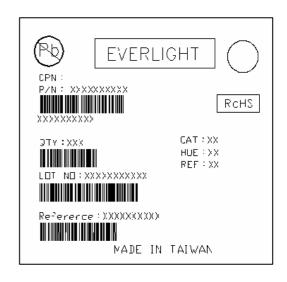
12-21/S2C-AQ2R2B/2C

Label explanation

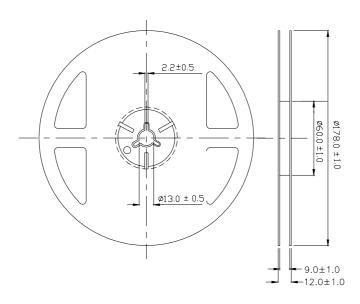
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Everlight Electronics Co., Ltd.

Device No.: DSE-0003457

http://www.everlight.com

Prepared date: 02-Apr-2010

Rev. 1

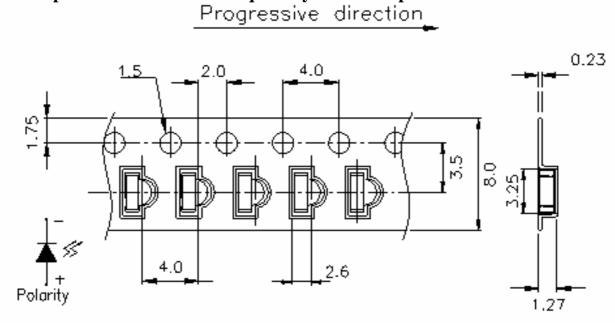
Page: 6 of 10

Prepared by: Deng Bo



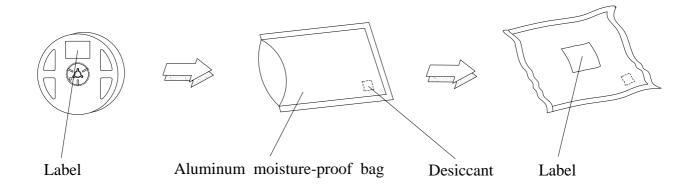
12-21/S2C-AQ2R2B/2C

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd.

http://www.everlight.com

Rev. 1

Page: 7 of 10

Device No.: DSE-0003457

Prepared date: 02-Apr-2010

Prepared by: Deng Bo



12-21/S2C-AQ2R2B/2C

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90 %

LTPD: 10 %

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Rc
1	Reflow Soldering	Temp. : 260°C±5°C Min5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85% R.H	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10



12-21/S2C-AQ2R2B/2C

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

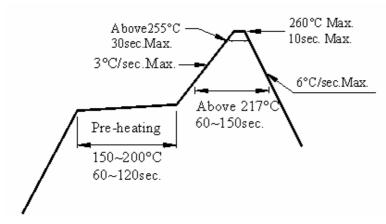
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 10 Device No.: DSE-0003457

Prepared date: 02-Apr-2010 Prepared by: Deng Bo



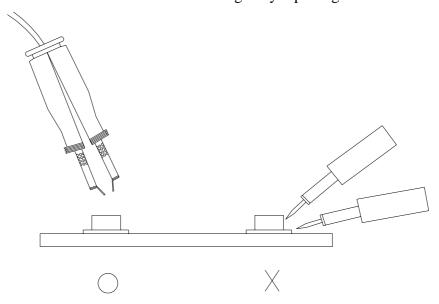
12-21/S2C-AQ2R2B/2C

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 10